TOSHIBA Phototransistor Silicon NPN Epitaxial Planar

TPS611(F)

Lead(Pb)-Free
Photoelectric Counter
Various Kinds Of Readers
Position Detection

• φ5mm epoxy resin package(black)

• High sensitivity: $I_L = 120\mu A(typ.)$

• Half value angle: $\theta 1/2 = \pm 8^{\circ}$ (typ.)

• Protected from external light by black mold packaging.

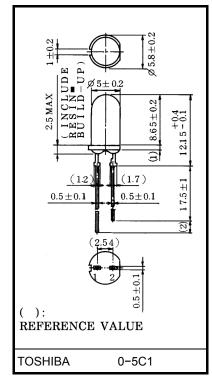
Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Collector-emitter voltage	V _{CEO}	30	V	
Emitter–Collector voltage	V _{ECO}	5	V	
Collector current	IC	50	mA	
Collector power dissipation	PC	150	mW	
Collector power dissipation derating(Ta>25°C)	ΔP _C /°C	-2	mW/°C	
Operating temperature range	T _{opr}	-20~75	°C	
Storage temperature range	T _{stg}	-30~100	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

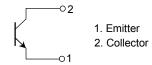
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Unit in mm



Weight: 0.3 g (typ.)

Pin Connection



Opto-electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition		Min	Тур.	Max	Unit
Dark current		I _D (I _{CEO})	I _F = 24V, E=0		_	0.005	0.1	μΑ
Light current		ΙL	V _{CE} = 3V, E=0.1mW/cm ²	(Note)	30	120	_	μΑ
Collector–emitter saturation voltage		V _{CE} (sat)	$I_C = 15\mu A, E=0.1 \text{mW/cm}^2$	(Note)	_	0.25	0.4	V
Switching time	Rise time	t _r	V_{CC} = 5V, I_C = 2mA R_L = 100 Ω		_	6	_	
	Fall time	t _f			_	6	_	μs
Peak sensitivity wavelength		λР	_		_	900	_	nm
Half value angle		$\theta \frac{1}{2}$	_		_	±8	_	o

Note: Color temperature = 2870K, standard tungsten lamp

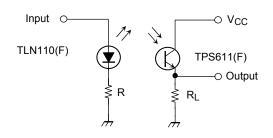
Precaution

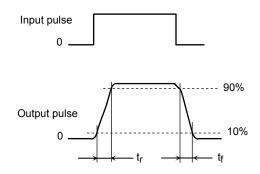
Please be careful of the followings.

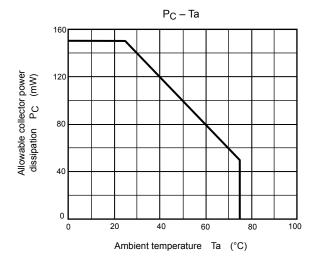
- 1. Soldering temperature: 260°C max. Soldering time: 5s max. (Soldering portion of lead: The top portion from the lead stopper.)
- 2. When the leads is formed, the lead shall be formed at the top portion of the stopper without leaving forming stress to the body of the device. Soldering shall be performed after lead forming.

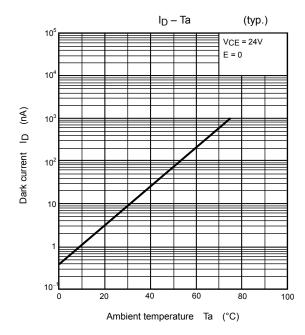
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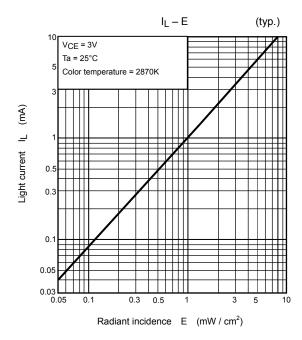
Fig.1 Switching time test circuit

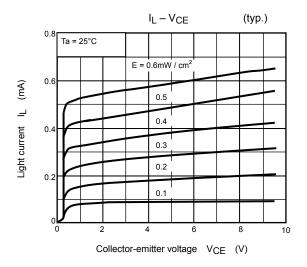


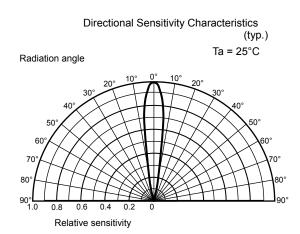


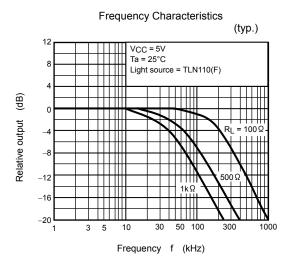


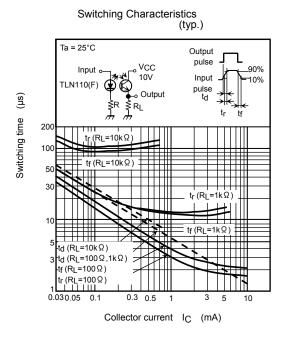


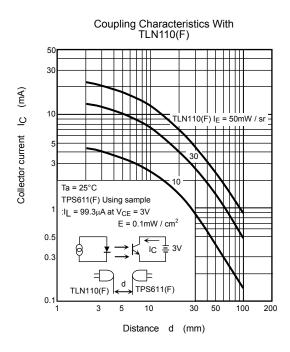


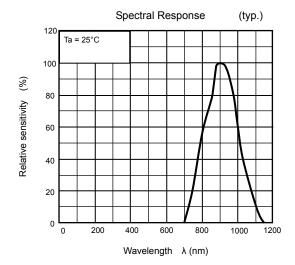












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RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

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